

SF305C

SF305C Halogen-free flame-resistant type polyimide film based Coverlay

FEATURES

- Halogen free, flammability UL94 V-0.High bonding strength, good dimensional stability and thermal resistance.
- Low adhesive flowing, good processability, suitable for both fast and traditional lamination style.
- Compatible with EU RoHS directive, free of Pb, Hg, Cd, Cr⁶⁺,PBB,PBDE, etc..

APPLICATIONS

Coverlay for FPC.

GENERAL PROPERTIES

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Test Item		Treatment Condition	Unit	Property Data		
				IPC	Typica	l Value
				Standard	SF305C 0515	SF305C 1025
Resin Flow		-	mm	-	<0.15	<0.15
Peel Strength (90°) ¹		А	N/mm	≥0.7	0.9	1.1
		288℃,5s		≥0.5	0.9	1.0
Thermal Stress ¹		300℃,10s	-	288℃,10s No delamination	No delamination	No delamination
Dimensional Stability	MD	E-0.5/150	%	±0.2	±0.1	±0.1
	TD				±0.1	±0.1
Chemical Resistance		After Chemical Exposure	%	≥80	>90	>90
Volume Resistivity		C-96/35/90	MΩ •cm	≥10 ⁶	5.5x10 ⁷	6.0x10 ⁷
Surface Resistance		C-96/35/90	M Ω	≥10⁴	3.0x10 ⁶	3.5x10 ⁶

Explanations: C = Humidity conditioning;

E = Temperature conditioning.

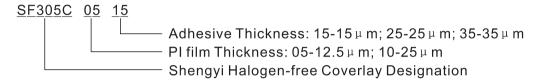
1. Testing after laminating with shining side of copper foil in suitable condition.



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Product Code Description

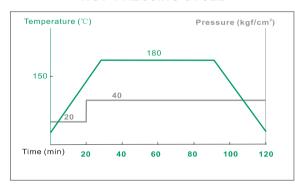


SPECIFICATIONS OF STANDARD PRODUCTS

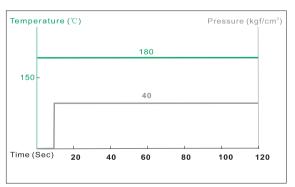
Specifications	PI film Thickness (μ m)	Adhesive Thickness (µ m)
SF305C 0515	12.5	15
SF305C 0520	12.5	20
SF305C 0525	12.5	25
SF305C 1025	25	25
SF305C 1030	25	30

PRESS PROPOSE

HOT PRESSING CYCLE



FAST PRESSING CYCLE



The parameters of hot Pressure need to be adjusted according to different equipment and product specifications. After fast press, the curing condition is $150-160^{\circ}$ for 60-90min.

PURCHASING INFORMATION

SF305C is supplied in rolls and standard widths of 250+2/-0mm or 500+2/-0mm. Roll length is 100+2/-0m or 200+2/-0m. Other sizes could be available upon request.

STORAGE CONDITION

Stored in the room of dryness. Three months when stored in the original packaging at $4-10^{\circ}$ C.